



#### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	Rds(on) Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
100\/	9mΩ @ V <sub>GS</sub> = 10V	13A
100V	13.8m $\Omega$ @ V <sub>GS</sub> = 4.5V	10A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

### **Features and Benefits**

- High Conversion Efficiency
- Low R<sub>DS(ON)</sub>—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

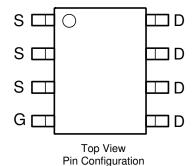
https://www.diodes.com/quality/product-definitions/

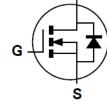
#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Finish—Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Top View





**Equivalent Circuit** 

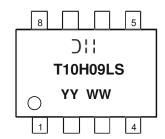
### Ordering Information (Note 4)

- 7			
ĺ	Part Number	Case	Packaging
	DMT10H009LSS-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging \ details, go \ to \ our \ website \ at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

## **Marking Information**





## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	100	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 6) Ves. 10V	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	l <sub>D</sub>	13 10	Α
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	lo	48 38	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	110	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	ls	2.5	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle	lsм	110	Α	
Avalanche Current, L = 0.3mH	las	21	Α	
Avalanche Energy, L = 0.3mH	E <sub>AS</sub>	66	mJ	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	68	°C/W
Total Power Dissipation (Note 6)	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	50	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	4	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

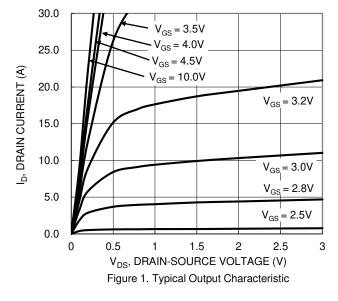
# Electrical Characteristics (TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	100	_	_	V	$V_{GS} = 0V$ , $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 80V$ , $V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.3		2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	7.1	9	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-nesistance	R <sub>DS(ON)</sub>		9.7	13.8	11122	$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		2309	l		V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss		536	l	pF		
Reverse Transfer Capacitance	Crss		13.7	l			
Gate Resistance	Rg		1.9		Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (VGS = 10V)	Qg	_	40.2	_			
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg		20.2		nC	V <sub>DD</sub> = 50V, I <sub>D</sub> = 20A	
Gate-Source Charge	Qgs	_	7.0	_	IIC	VDD = 50V, ID = 20A	
Gate-Drain Charge	Qgd	_	8.5	_			
Turn-On Delay Time	tD(ON)	_	5.4			$\begin{split} V_{DD} &= 50 \text{V}, \text{ V}_{GS} = 10 \text{V}, \\ I_{D} &= 20 \text{A}, \text{ R}_{g} = 3 \Omega \end{split}$	
Turn-On Rise Time	tR	_	10.6	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	28.3	_	115		
Turn-Off Fall Time	tr	_	14.9				
Body Diode Reverse Recovery Time	t <sub>RR</sub>	1	44.3	1	ns	I= 20.4 di/dt 100.4/us	
Body Diode Reverse Recovery Charge	Qrr	1	65.5	1	nC	IF = 20A, di/dt = 100A/µs	

5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate. Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





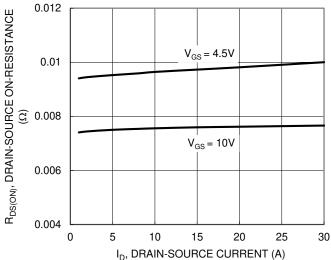


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

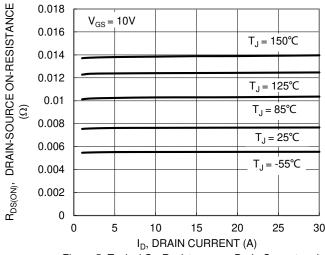


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

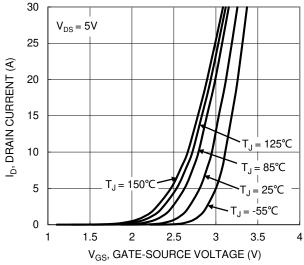


Figure 2. Typical Transfer Characteristic

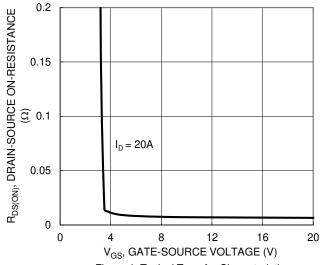


Figure 4. Typical Transfer Characteristic

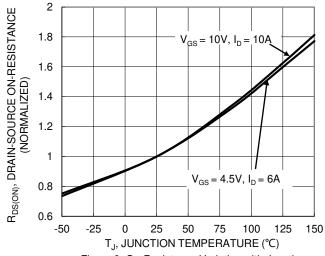


Figure 6. On-Resistance Variation with Junction Temperature





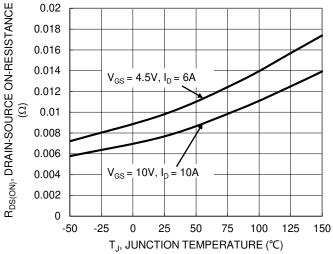
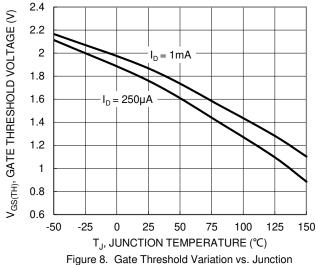


Figure 7. On-Resistance Variation with Junction Temperature



Temperature

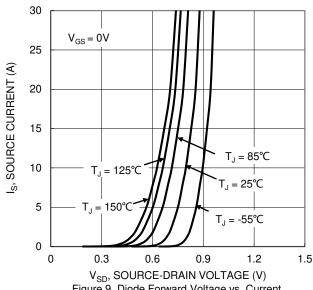
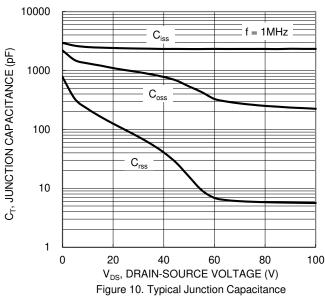


Figure 9. Diode Forward Voltage vs. Current



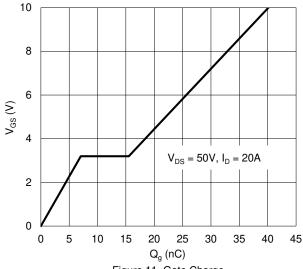
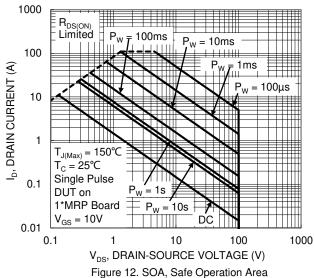


Figure 11. Gate Charge





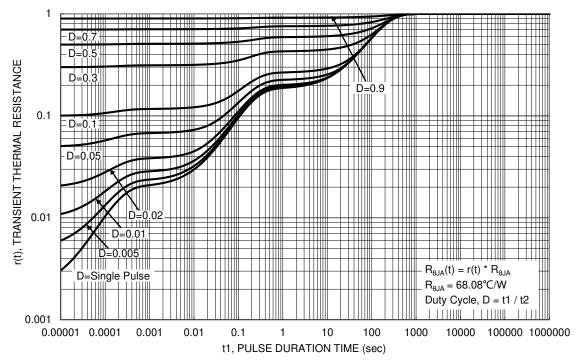
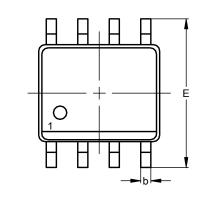


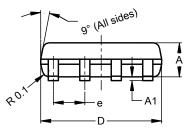
Figure 13. Transient Thermal Resistance

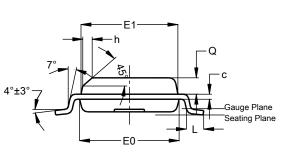


### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





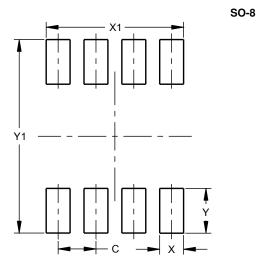


SO-8

SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h			0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



<b>Dimensions</b>	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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